

BCR1AM-12

Triac

Low Power Use

REJ03G0344-0100 Rev.1.00 Aug.20.2004

Features

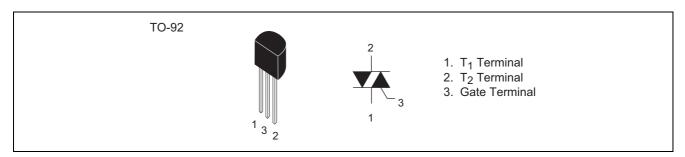
• I_{FGTI} , I_{RGTII} , I_{RGTIII} : 5 mA (3 mA) Note5

• I_{FGTIII}: 10 mA

Non-Insulated Type

• Glass Passivation Type

Outline



Applications

Contactless AC switch, fan motor, rice-cooker, electric pot, air cleaner, heater, refrigerator, washing machine, electric fan, vending machine, trigger circuit for low and medium triac, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit	
Farameter	Syllibol	12		
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V	
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	720	V	

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I _{T (RMS)}	1.0	А	Commercial frequency, sine full wave 360° conduction, Tc = 56°C ^{Note3}
Surge on-state current	I _{TSM}	10	А	60Hz sinewave 1 full cycle, peak value, non-repetitive
I ² t for fusing	l ² t	0.41	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	1	W	
Average gate power dissipation	P _{G (AV)}	0.1	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I _{GM}	0.5	Α	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	_	0.23	g	Typical value

Notes: 1. Gate open.

Electrical Characteristics

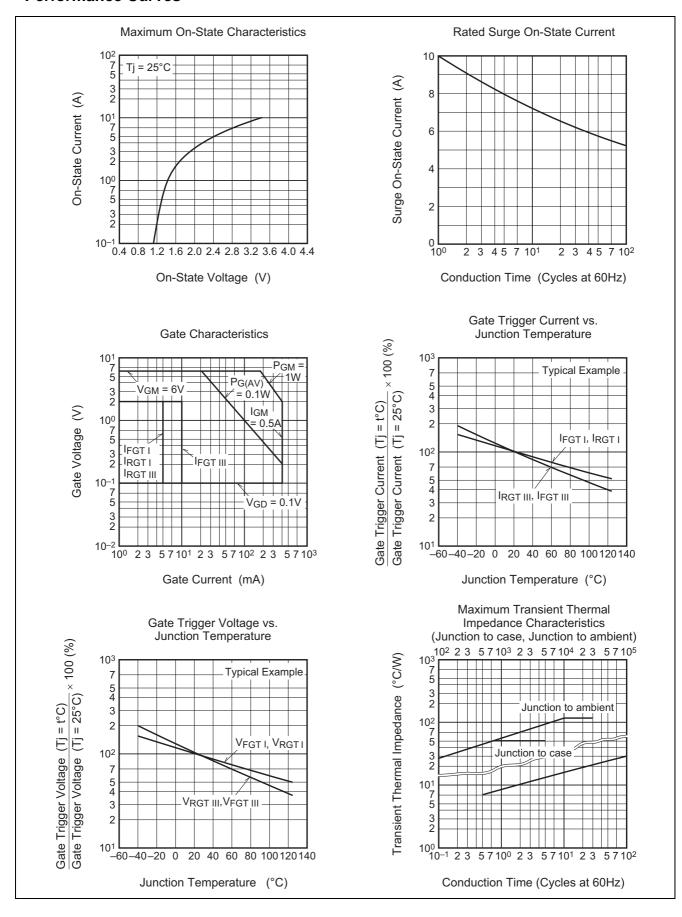
Parameter		Symbol	F	Rated value			Test conditions	
		Symbol	Min.	Тур.	Max.	Unit	rest conditions	
Repetitive peak off-state cur	rent	I _{DRM}	_	_	0.5	mA	Tj = 125°C, V _{DRM} applied	
On-state voltage		V_{TM}	_	_	1.6	V	$Tc = 25^{\circ}C, I_{TM} = 1.5 A,$	
							Instantaneous measurement	
Gate trigger voltage ^{Note2}	I	V_{FGTI}	_	_	2.0	V	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,	
	II	V_{RGTI}	_	_	2.0	V	$R_G = 330 \Omega$	
	III	V_{RGTIII}	_	_	2.0	V		
	IV	V_{FGTIII}	_	_	2.0	V		
Gate trigger current ^{Note2}	I	I_{FGTI}	_	_	5	mA	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,	
II		I_{RGTI}	_	_	5 ^{Note5}	mA	$R_G = 330 \Omega$	
	III	I _{RGTIII}	_	_	5 ^{Note5}	mA		
	IV	I _{FGTIII}	_	_	10	mA		
Gate non-trigger voltage		V_{GD}	0.1	_	_	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM}$	
Thermal resistance		R _{th (j-c)}	_	_	50	°C/W	Junction to case ^{Note3}	
Critical-rate of rise of off-state commutating voltage ^{Note4}		(dv/dt)c	2	_	_	V/μs	Tj = 125°C	

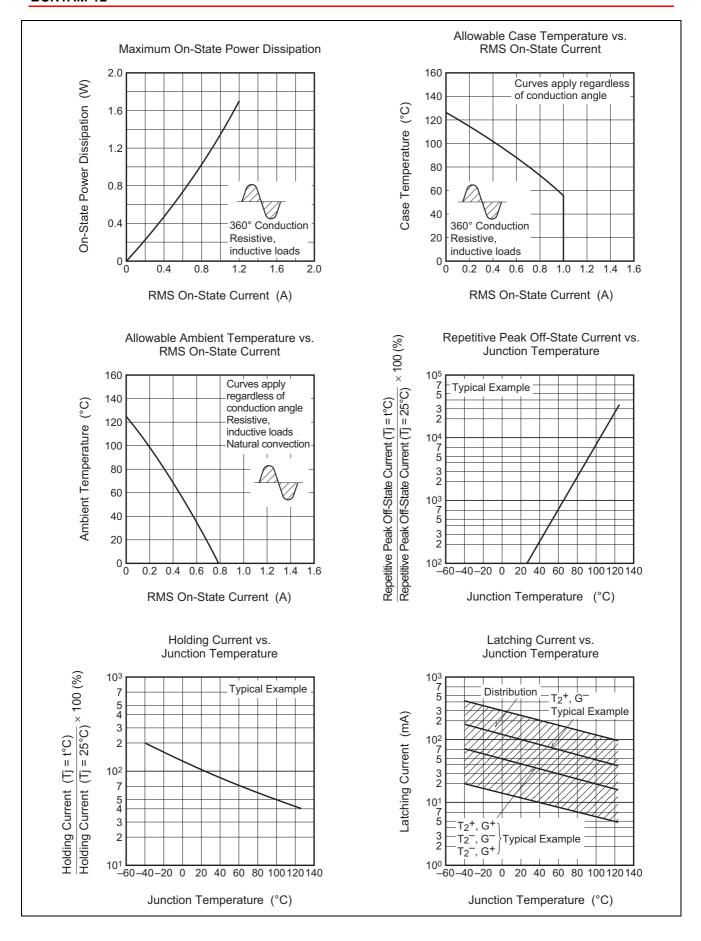
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

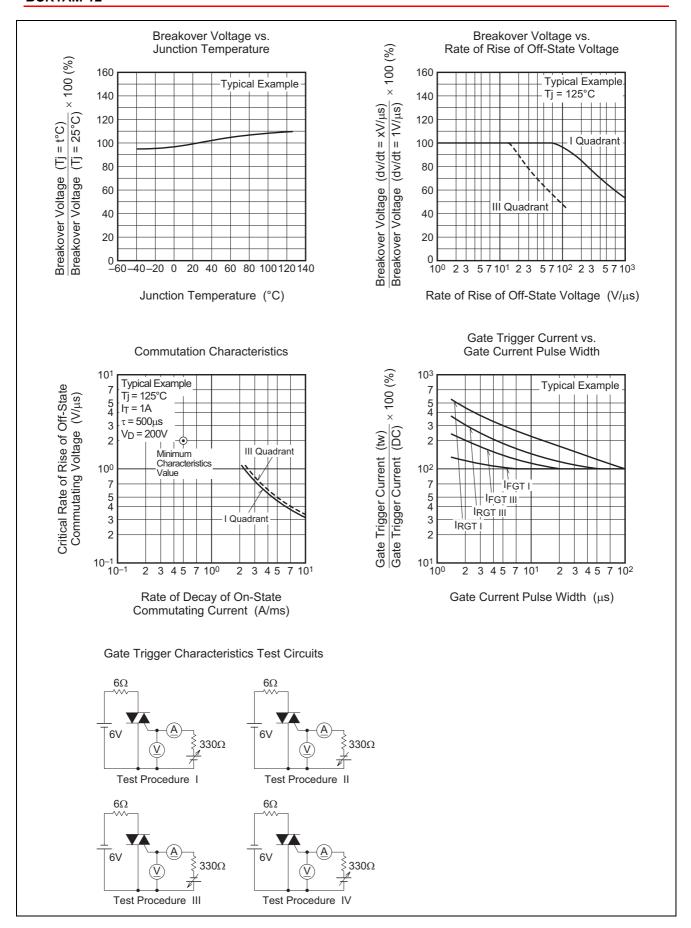
- 3. Case temperature is measured at the T_2 terminal 1.5 mm away from the molded case.
- 4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.
- 5. High sensitivity ($I_{GT} \le 3$ mA) is also available. (I_{GT} item: 1)

Test conditions	Commutating voltage and current waveforms (inductive load)		
1. Junction temperature Tj = 125°C	Supply Voltage →Time		
2. Rate of decay of on-state commutating current (di/dt)c = - 0.5 A/ms	Main Current — (di/dt)c — Time		
3. Peak off-state voltage V _D = 400 V	Main Voltage Time		

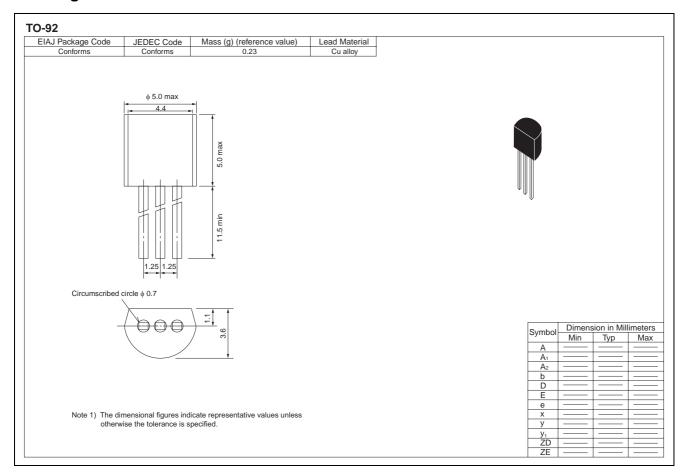
Performance Curves







Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example	
Straight type	Vinyl sack	500	Type name	BCR1AM-12	
Lead form	Vinyl sack	500	Type name – Lead forming code	BCR1AM-12-A6	
Form A8	Taping	2000	Type name – TB	BCR1AM-12-TB	

Note: Please confirm the specification about the shipping in detail.

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